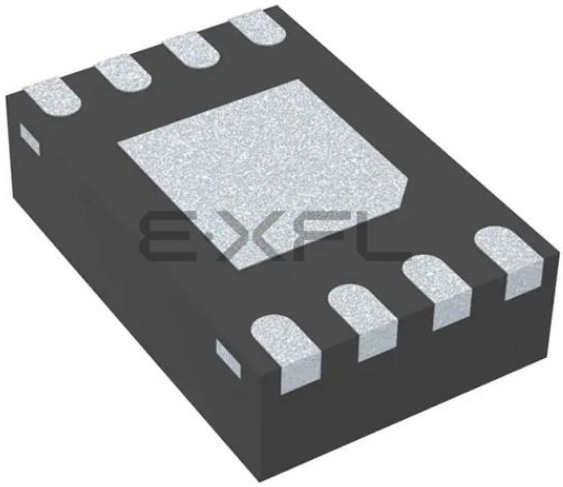

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Peripherals	POR, WDT
Number of I/O	3
Program Memory Size	768B (512 x 12)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	24 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
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2.0 PIC10F200/202/204/206 DEVICE VARIETIES

A variety of packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in this section. When placing orders, please use the PIC10F200/202/204/206 Product Identification System at the back of this data sheet to specify the correct part number.

2.1 Quick Turn Programming (QTP) Devices

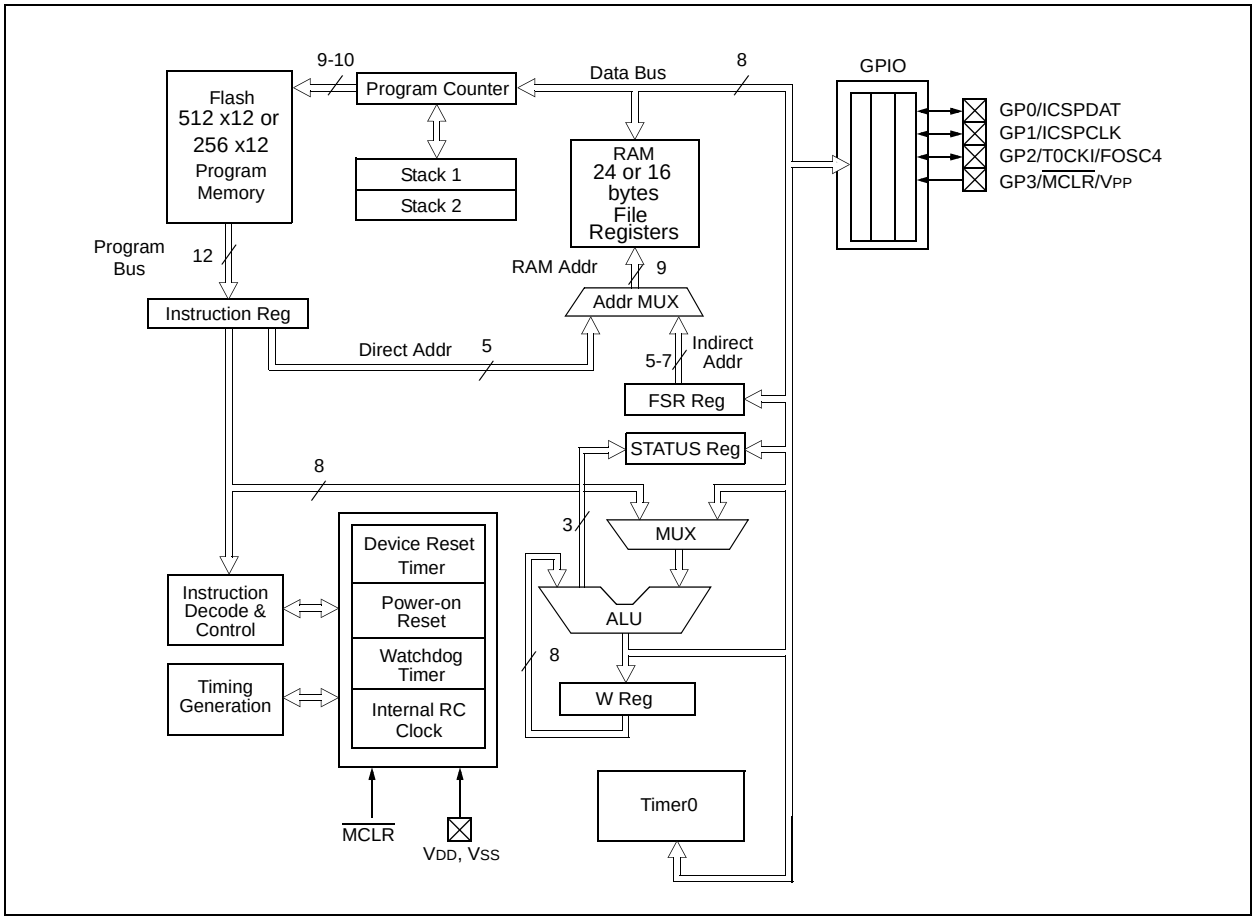
Microchip offers a QTP programming service for factory production orders. This service is made available for users who choose not to program medium-to-high quantity units and whose code patterns have stabilized. The devices are identical to the Flash devices but with all Flash locations and fuse options already programmed by the factory. Certain code and prototype verification procedures do apply before production shipments are available. Please contact your local Microchip Technology sales office for more details.

2.2 Serialized Quick Turn Programming^{SM} (SQTP^{SM}) Devices

Microchip offers a unique programming service, where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number, which can serve as an entry code, password or ID number.

FIGURE 3-1: PIC10F200/202 BLOCK DIAGRAM



4.0 MEMORY ORGANIZATION

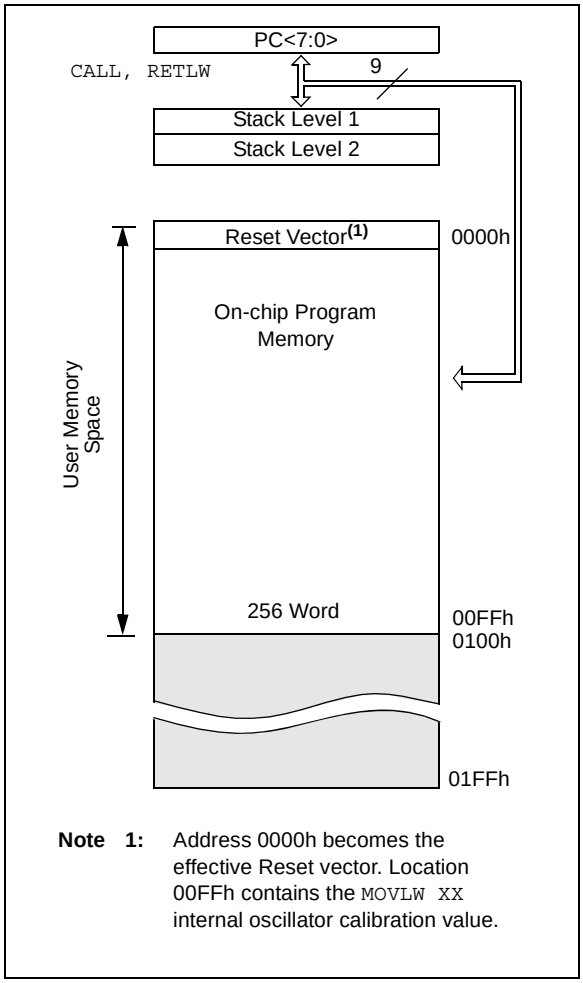
The PIC10F200/202/204/206 memories are organized into program memory and data memory. Data memory banks are accessed using the File Select Register (FSR).

4.1 Program Memory Organization for the PIC10F200/204

The PIC10F200/204 devices have a 9-bit Program Counter (PC) capable of addressing a 512 x 12 program memory space.

Only the first 256 x 12 (0000h-00FFh) for the PIC10F200/204 are physically implemented (see Figure 4-1). Accessing a location above these boundaries will cause a wraparound within the first 256 x 12 space (PIC10F200/204). The effective Reset vector is at 0000h (see Figure 4-1). Location 00FFh (PIC10F200/204) contains the internal clock oscillator calibration value. This value should never be overwritten.

FIGURE 4-1: PROGRAM MEMORY MAP AND STACK FOR THE PIC10F200/204



Note 1: Address 0000h becomes the effective Reset vector. Location 00FFh contains the `MOVLW XX` internal oscillator calibration value.

4.6 OSCCAL Register

The Oscillator Calibration (OSCCAL) register is used to calibrate the internal precision 4 MHz oscillator. It contains seven bits for calibration**.**

Note:	Erasing the device will also erase the pre-programmed internal calibration value for the internal oscillator. The calibration value must be read prior to erasing the part so it can be reprogrammed correctly later.

After you move in the calibration constant, do not change the value. See **Section 9.2.2 "Internal 4 MHz Oscillator"**.

REGISTER 4-3: OSCCAL REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-0
CAL6	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	FOSC4
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-1 **CAL<6:0>:** Oscillator Calibration bits

0111111 = Maximum frequency
•
•
•
0000001
0000000 = Center frequency
1111111
•
•
•
1000000 = Minimum frequency

bit 0 **FOSC4:** INTOSC/4 Output Enable bit(1)

1 = INTOSC/4 output onto GP2
0 = GP2/T0CKI/COUT applied to GP2

Note 1: Overrides GP2/T0CKI/COUT control registers when enabled.

5.0 I/O PORT

As with any other register, the I/O register(s) can be written and read under program control. However, read instructions (e.g., MOVF GPIO, W) always read the I/O pins independent of the pin's Input/Output modes. On Reset, all I/O ports are defined as input (inputs are at high-impedance) since the I/O control registers are all set.

5.1 GPIO

GPIO is an 8-bit I/O register. Only the low-order 4 bits are used (GP<3:0>). Bits 7 through 4 are unimplemented and read as '0's. Please note that GP3 is an input-only pin. Pins GP0, GP1 and GP3 can be configured with weak pull-ups and also for wake-up on change. The wake-up on change and weak pull-up functions are not pin selectable. If GP3/MCLR is configured as MCLR, weak pull-up is always on and wake-up on change for this pin is not enabled.

5.2 TRIS Registers

The Output Driver Control register is loaded with the contents of the W register by executing the TRIS f instruction. A '1' from a TRIS register bit puts the corresponding output driver in a High-Impedance mode. A '0' puts the contents of the output data latch on the selected pins, enabling the output buffer. The exceptions are GP3, which is input-only and the GP2/T0CKI/COUT/FOSC4 pin, which may be controlled by various registers. See Table 5-1.

Note:	A read of the ports reads the pins, not the output data latches. That is, if an output driver on a pin is enabled and driven high, but the external system is holding it low, a read of the port will indicate that the pin is low.

The TRIS registers are "write-only" and are set (output drivers disabled) upon Reset.

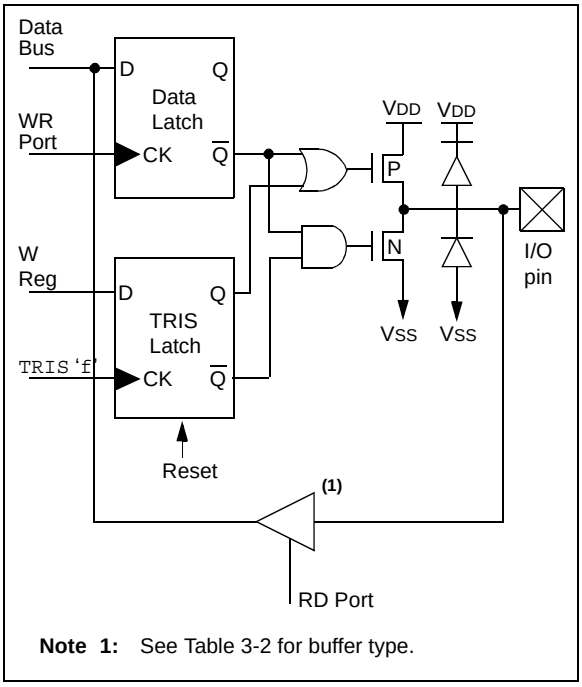
TABLE 5-1: ORDER OF PRECEDENCE FOR PIN FUNCTIONS

Priority	GP0	GP1	GP2	GP3
1	CIN+	CIN-	FOSC4	I/MCLR
2	TRIS GPIO	TRIS GPIO	COUT	—
3	—	—	T0CKI	—
4	—	—	TRIS GPIO	—

5.3 I/O Interfacing

The equivalent circuit for an I/O port pin is shown in Figure 5-1. All port pins, except GP3 which is input-only, may be used for both input and output operations. For input operations, these ports are non-latching. Any input must be present until read by an input instruction (e.g., MOVF GPIO, W). The outputs are latched and remain unchanged until the output latch is rewritten. To use a port pin as output, the corresponding direction control bit in TRIS must be cleared (= 0). For use as an input, the corresponding TRIS bit must be set. Any I/O pin (except GP3) can be programmed individually as input or output.

FIGURE 5-1: PIC10F200/202/204/206 EQUIVALENT CIRCUIT FOR A SINGLE I/O PIN



Note 1: See Table 3-2 for buffer type.

TABLE 5-2: SUMMARY OF PORT REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-On Reset	Value on All Other Resets
N/A	TRISGPIO	—	—	—	—	I/O Control Register				---- 1111	---- 1111
N/A	OPTION	$\overline{\text{GPWU}}$	$\overline{\text{GPPU}}$	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
03h	STATUS	GPWUF	CWUF	—	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	00-1 1xxx	qq-q quuu(1), (2)
06h	GPIO	—	—	—	—	GP3	GP2	GP1	GP0	---- xxxx	---- uuuu

Legend: Shaded cells are not used by PORT registers, read as '0', – = unimplemented, read as '0', x = unknown, u = unchanged, q = depends on condition.

Note 1: If Reset was due to wake-up on pin change, then bit 7 = 1. All other Resets will cause bit 7 = 0.

2: If Reset was due to wake-up on comparator change, then bit 6 = 1. All other Resets will cause bit 6 = 0.

5.4 I/O Programming Considerations

5.4.1 BIDIRECTIONAL I/O PORTS

Some instructions operate internally as read followed by write operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation and rewrite the result. Caution must be used when these instructions are applied to a port where one or more pins are used as input/outputs. For example, a BSF operation on bit 2 of GPIO will cause all eight bits of GPIO to be read into the CPU, bit 2 to be set and the GPIO value to be written to the output latches. If another bit of GPIO is used as a bidirectional I/O pin (say bit 0), and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and rewritten to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the Input mode, no problem occurs. However, if bit 0 is switched into Output mode later on, the content of the data latch may now be unknown.

Example 5-1 shows the effect of two sequential Read-Modify-Write instructions (e.g., BCF, BSF, etc.) on an I/O port.

A pin actively outputting a high or a low should not be driven from external devices at the same time in order to change the level on this pin ("wired OR", "wired AND"). The resulting high output currents may damage the chip.

EXAMPLE 5-1: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

```
;Initial GPIO Settings
;GPIO<3:2> Inputs
;GPIO<1:0> Outputs
;
;                 GPIO latch   GPIO pins
;                 ----------   ----------
 BCF    GPIO,  1 ;---- pp01    ---- pp11
 BCF    GPIO,  0 ;---- pp10    ---- pp11
 MOVLW  007h;
 TRIS   GPIO     ;---- pp10    ---- pp11
;
```

Note 1: The user may have expected the pin values to be ---- pp00. The 2nd BCF caused GP1 to be latched as the pin value (High).

5.4.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-2). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should allow the pin voltage to stabilize (load dependent) before the next instruction causes that file to be read into the CPU. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with a NOP or another instruction not accessing this I/O port.

6.0 TIMER0 MODULE AND TMR0 REGISTER (PIC10F200/202)

The Timer0 module has the following features:

- 8-bit timer/counter register, TMR0
- Readable and writable
- 8-bit software programmable prescaler
- Internal or external clock select:
  - Edge select for external clock

Figure 6-1 is a simplified block diagram of the Timer0 module.

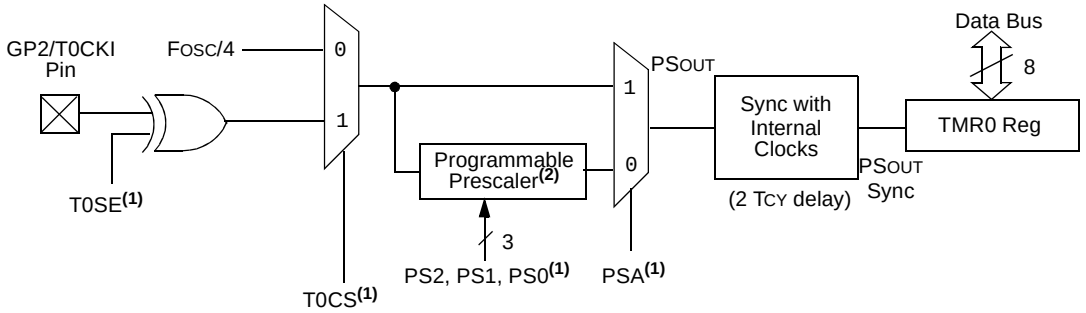
Timer mode is selected by clearing the T0CS bit (OPTION<5>). In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If TMR0 register is written, the increment is inhibited for the following two cycles (Figure 6-2 and Figure 6-3). The user can work around this by writing an adjusted value to the TMR0 register.

Counter mode is selected by setting the T0CS bit (OPTION<5>). In this mode, Timer0 will increment either on every rising or falling edge of pin T0CKI. The T0SE bit (OPTION<4>) determines the source edge. Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in **Section 6.1 "Using Timer0 with an External Clock (PIC10F200/202)"**.

The prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both. The prescaler assignment is controlled in software by the control bit, PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4, 1:256 are selectable. **Section 6.2 "Prescaler"** details the operation of the prescaler.

A summary of registers associated with the Timer0 module is found in Table 6-1.

FIGURE 6-1: TIMER0 BLOCK DIAGRAM



Note 1: Bits T0CS, T0SE, PSA, PS2, PS1 and PS0 are located in the OPTION register.

2: The prescaler is shared with the Watchdog Timer (Figure 6-5).

FIGURE 6-2: TIMER0 TIMING: INTERNAL CLOCK/NO PRESCALE

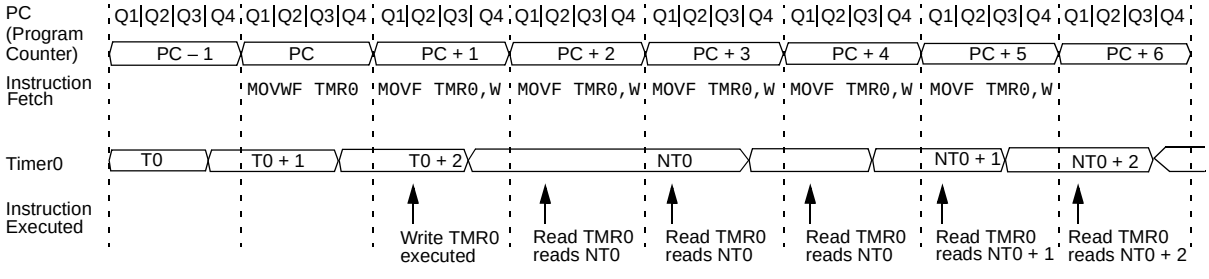


FIGURE 6-3: TIMER0 TIMING: INTERNAL CLOCK/PRESCALE 1:2

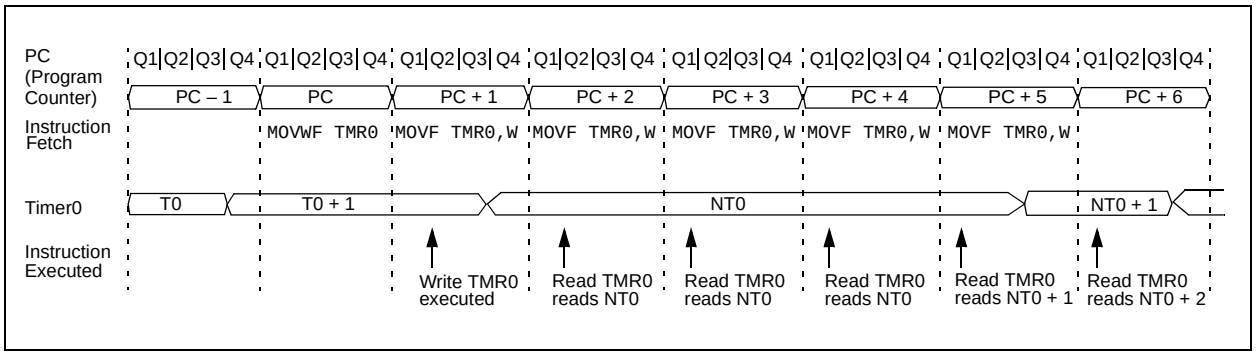


TABLE 6-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-On Reset	Value on All Other Resets
01h	TMR0	Timer0 – 8-bit Real-Time Clock/Counter								xxxx xxxx	uuuu uuuu
N/A	OPTION	GPWU	GPPU	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
N/A	TRISGPIO(1)	—	—	—	—	I/O Control Register				---- 1111	---- 1111

Legend: Shaded cells not used by Timer0. – = unimplemented, x = unknown, u = unchanged.

Note 1: The TRIS of the T0CKI pin is overridden when T0CS = 1.

6.1 Using Timer0 with an External Clock (PIC10F200/202)

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (TOSC) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

6.1.1 EXTERNAL CLOCK SYNCHRONIZATION

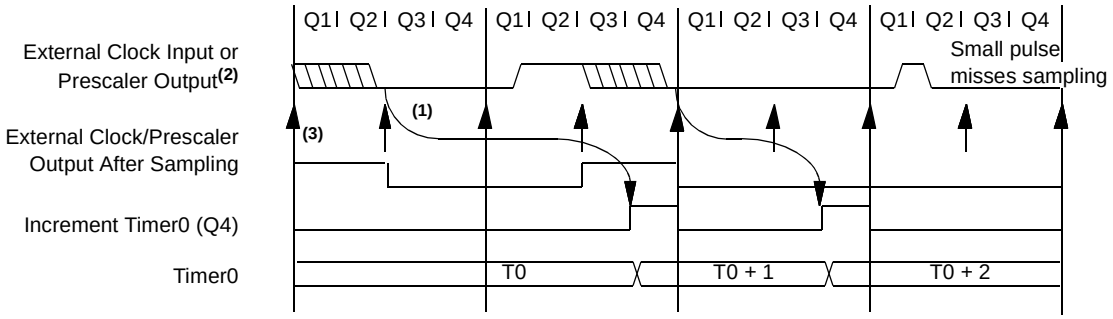
When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 6-4). Therefore, it is necessary for T0CKI to be high for at least 2 TOSC (and a small RC delay of 2 Tt0H) and low for at least 2 TOSC (and a small RC delay of 2 Tt0H). Refer to the electrical specification of the desired device.

When a prescaler is used, the external clock input is divided by the asynchronous ripple counter-type prescaler, so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for T0CKI to have a period of at least 4 TOSC (and a small RC delay of 4 Tt0H) divided by the prescaler value. The only requirement on T0CKI high and low time is that they do not violate the minimum pulse width requirement of Tt0H. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

6.1.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 6-4 shows the delay from the external clock edge to the timer incrementing.

FIGURE 6-4: TIMER0 TIMING WITH EXTERNAL CLOCK



Note 1: Delay from clock input change to Timer0 increment is 3 TOSC to 7 TOSC (Duration of Q = TOSC). Therefore, the error in measuring the interval between two edges on Timer0 input = ±4 TOSC max.

2: External clock if no prescaler selected; prescaler output otherwise.

3: The arrows indicate the points in time where sampling occurs.

6.2 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module or as a postscaler for the Watchdog Timer (WDT), respectively (see **Section 9.6 "Watchdog Timer (WDT)"**). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet.

Note:	The prescaler may be used by either the Timer0 module or the WDT, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the WDT and vice versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., `CLRF 1`, `MOVWF 1`, `BSF 1,x`, etc.) will clear the prescaler. When assigned to WDT, a `CLRWDT` instruction will clear the prescaler along with the WDT. The prescaler is neither readable nor writable. On a Reset, the prescaler contains all '0's.

6.2.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed "on-the-fly" during program execution). To avoid an unintended device Reset, the following instruction sequence (Example 6-1) must be executed when changing the prescaler assignment from Timer0 to the WDT.

EXAMPLE 6-1: CHANGING PRESCALER (TIMER0 → WDT)

```
CLRWDT              ;Clear WDT
CLRF   TMR0         ;Clear TMR0 & Prescaler
MOVLW  '00xx1111'b  ;These 3 lines (5, 6, 7)
OPTION              ;are required only if
                    ;desired
CLRWDT              ;PS<2:0> are 000 or 001
MOVLW  '00xx1xxx'b  ;Set Postscaler to
OPTION              ;desired WDT rate
```

FIGURE 8-3: ANALOG INPUT MODE

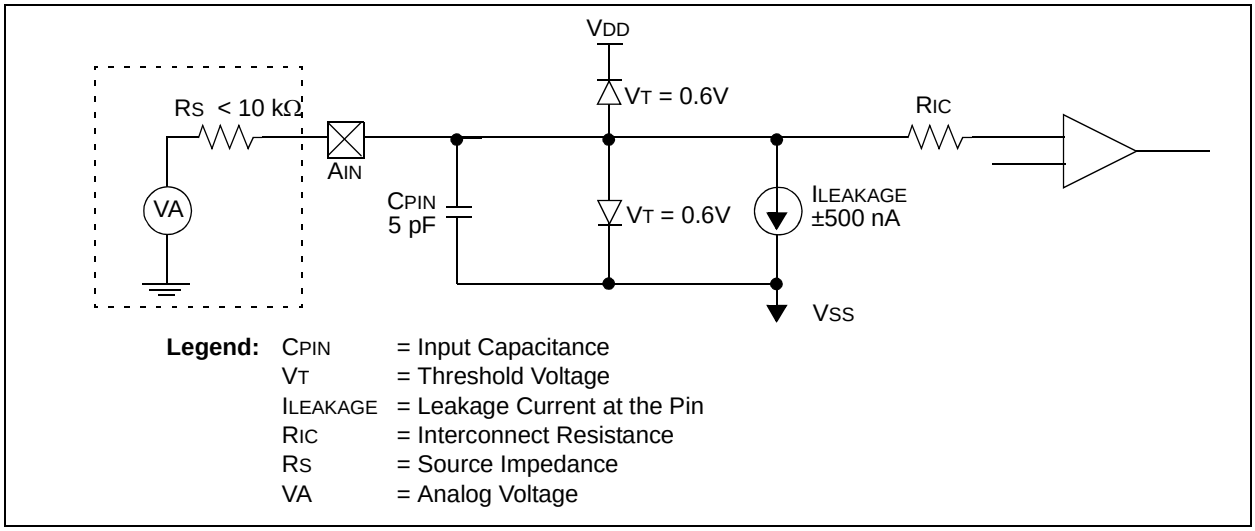


TABLE 8-2: REGISTERS ASSOCIATED WITH COMPARATOR MODULE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on All Other Resets
03h	STATUS	GPWUF	CWUF	—	$\overline{TO}$	$\overline{PD}$	Z	DC	C	00-1 1xxx	qq0q quuu
07h	CMCON0	CMPOUT	$\overline{COUTEN}$	POL	$\overline{CMPT0CS}$	CMPON	CNREF	CPREF	$\overline{CWU}$	1111 1111	uuuu uuuu
N/A	TRISGPIO	—	—	—	—	I/O Control Register				---- 1111	---- 1111

Legend: x = Unknown, u = Unchanged, – = Unimplemented, read as '0', q = Depends on condition.

9.7 Time-out Sequence, Power-down and Wake-up from Sleep Status Bits (TO, PD, GPWUF, CWUF)

The $\overline{TO}$, $\overline{PD}$, GPWUF and CWUF bits in the STATUS register can be tested to determine if a Reset condition has been caused by a power-up condition, a $\overline{MCLR}$, Watchdog Timer (WDT) Reset, wake-up on comparator change or wake-up on pin change.

TABLE 9-5: $\overline{TO}$, $\overline{PD}$, GPWUF, CWUF STATUS AFTER RESET

CWUF	GPWUF	$\overline{TO}$	$\overline{PD}$	Reset Caused By
0	0	0	0	WDT wake-up from Sleep
0	0	0	u	WDT time-out (not from Sleep)
0	0	1	0	$\overline{MCLR}$ wake-up from Sleep
0	0	1	1	Power-up
0	0	u	u	$\overline{MCLR}$ not during Sleep
0	1	1	0	Wake-up from Sleep on pin change
1	0	1	0	Wake-up from Sleep on comparator change

Legend: u = unchanged, x = unknown, – = unimplemented bit, read as '0', q = value depends on condition.

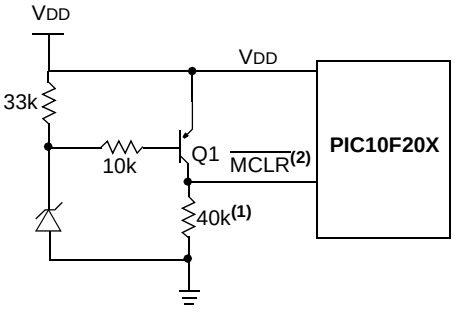
Note 1: The $\overline{TO}$, $\overline{PD}$, GPWUF and CWUF bits maintain their status (u) until a Reset occurs. A low-pulse on the $\overline{MCLR}$ input does not change the $\overline{TO}$, $\overline{PD}$, GPWUF or CWUF Status bits.

9.8 Reset on Brown-out

A Brown-out Reset is a condition where device power (V_{DD}) dips below its minimum value, but not to zero, and then recovers. The device should be reset in the event of a brown-out.

To reset PIC10F200/202/204/206 devices when a Brown-out Reset occurs, external brown-out protection circuits may be built, as shown in Figure 9-7 and Figure 9-8.

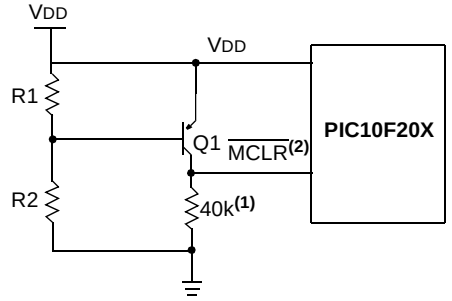
FIGURE 9-7: BROWN-OUT PROTECTION CIRCUIT 1



Note 1: This circuit will activate Reset when V_{DD} goes below Vz + 0.7V (where Vz = Zener voltage).

2: Pin must be confirmed as $\overline{MCLR}$.

FIGURE 9-8: BROWN-OUT PROTECTION CIRCUIT 2



Note 1: This brown-out circuit is less expensive, although less accurate. Transistor Q1 turns off when V_{DD} is below a certain level such that:

$$V_{DD} \bullet \frac{R1}{R1 + R2} = 0.7V$$

2: Pin must be confirmed as $\overline{MCLR}$.

BTFSS	Bit Test f, Skip if Set
Syntax:	[*label*] BTFSS f,b
Operands:	$0 \le f \le 31$ $0 \le b < 7$
Operation:	skip if (f<b>) = 1
Status Affected:	None
Description:	If bit 'b' in register 'f' is '1', then the next instruction is skipped. If bit 'b' is '1', then the next instruction fetched during the current instruction execution, is discarded and a NOP is executed instead, making this a 2-cycle instruction.

CALL	Subroutine Call
Syntax:	[*label*] CALL k
Operands:	$0 \le k \le 255$
Operation:	(PC) + 1→ Top-of-Stack; k → PC<7:0>; (STATUS<6:5>) → PC<10:9>; 0 → PC<8>
Status Affected:	None
Description:	Subroutine call. First, return address (PC + 1) is PUSHed onto the stack. The 8-bit immediate address is loaded into PC bits <7:0>. The upper bits PC<10:9> are loaded from STATUS<6:5>, PC<8> is cleared. CALL is a 2-cycle instruction.

CLRF	Clear f
Syntax:	[*label*] CLRF f
Operands:	$0 \le f \le 31$
Operation:	00h → (f); 1 → Z
Status Affected:	Z
Description:	The contents of register 'f' are cleared and the Z bit is set.

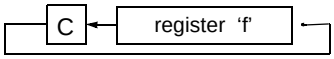
CLRW	Clear W
Syntax:	[*label*] CLRW
Operands:	None
Operation:	00h → (W); 1 → Z
Status Affected:	Z
Description:	The W register is cleared. Zero bit (Z) is set.

CLRWDT	Clear Watchdog Timer
Syntax:	[*label*] CLRWDT
Operands:	None
Operation:	00h → WDT; 0 → WDT prescaler (if assigned); 1 → $\overline{TO}$; 1 → $\overline{PD}$
Status Affected:	$\overline{TO}$, $\overline{PD}$
Description:	The CLRWDT instruction resets the WDT. It also resets the prescaler, if the prescaler is assigned to the WDT and not Timer0. Status bits $\overline{TO}$ and $\overline{PD}$ are set.

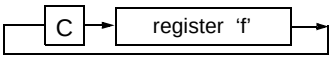
COMF	Complement f
Syntax:	[*label*] COMF f,d
Operands:	$0 \le f \le 31$ $d \in [0,1]$
Operation:	$(\bar{f}) \rightarrow$ (dest)
Status Affected:	Z
Description:	The contents of register 'f' are complemented. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

RETLW	Return with literal in W
Syntax:	[*label*] RETLW k
Operands:	$0 \le k \le 255$
Operation:	$k \rightarrow (W)$; $TOS \rightarrow PC$
Status Affected:	None
Description:	The W register is loaded with the 8-bit literal ‘k’. The program counter is loaded from the top of the stack (the return address). This is a 2-cycle instruction.

RLF	Rotate Left f through Carry
Syntax:	[*label*] RLF f,d
Operands:	$0 \le f \le 31$ $d \in [0,1]$
Operation:	See description below
Status Affected:	C
Description:	The contents of register ‘f’ are rotated one bit to the left through the Carry flag. If ‘d’ is ‘0’, the result is placed in the W register. If ‘d’ is ‘1’, the result is stored back in register ‘f’.



RRF	Rotate Right f through Carry
Syntax:	[*label*] RRF f,d
Operands:	$0 \le f \le 31$ $d \in [0,1]$
Operation:	See description below
Status Affected:	C
Description:	The contents of register ‘f’ are rotated one bit to the right through the Carry flag. If ‘d’ is ‘0’, the result is placed in the W register. If ‘d’ is ‘1’, the result is placed back in register ‘f’.



SLEEP	Enter SLEEP Mode
Syntax:	[*label*] SLEEP
Operands:	None
Operation:	$00h \rightarrow WDT$; $0 \rightarrow$ WDT prescaler; $1 \rightarrow \overline{TO}$; $0 \rightarrow \overline{PD}$
Status Affected:	$\overline{TO}$, $\overline{PD}$, RBWUF
Description:	Time-out Status bit ($\overline{TO}$) is set. The Power-down Status bit ($\overline{PD}$) is cleared. RBWUF is unaffected. The WDT and its prescaler are cleared. The processor is put into Sleep mode with the oscillator stopped. See **Section 9.9 “Power-down Mode (Sleep)”** for more details.

SUBWF	Subtract W from f
Syntax:	[*label*] SUBWF f,d
Operands:	$0 \le f \le 31$ $d \in [0,1]$
Operation:	$(f) - (W) \rightarrow (dest)$
Status Affected:	C, DC, Z
Description:	Subtract (2’s complement method) the W register from register ‘f’. If ‘d’ is ‘0’, the result is stored in the W register. If ‘d’ is ‘1’, the result is stored back in register ‘f’.

SWAPF	Swap Nibbles in f
Syntax:	[*label*] SWAPF f,d
Operands:	$0 \le f \le 31$ $d \in [0,1]$
Operation:	$(f<3:0>) \rightarrow (dest<7:4>)$; $(f<7:4>) \rightarrow (dest<3:0>)$
Status Affected:	None
Description:	The upper and lower nibbles of register ‘f’ are exchanged. If ‘d’ is ‘0’, the result is placed in W register. If ‘d’ is ‘1’, the result is placed in register ‘f’.

TABLE 12-3: CALIBRATED INTERNAL RC FREQUENCIES – PIC10F200/202/204/206

AC CHARACTERISTICS			Standard Operating Conditions (unless otherwise specified) Operating Temperature -40°C ≤ TA ≤ +85°C (industrial), -40°C ≤ TA ≤ +125°C (extended) Operating Voltage VDD range is described in **Section 12.1 "DC Characteristics: PIC10F200/202/204/206 (Industrial)"**					
Param. No.	**Sym.**	**Characteristic**	**Freq. Tolerance**	**Min.**	**Typ.†**	**Max.**	**Units**	**Conditions**
F10	FOSC	Internal Calibrated INTOSC Frequency(1,2)	± 1%	3.96	4.00	4.04	MHz	VDD=3.5V @ 25°C
			± 2%	3.92	4.00	4.08	MHz	2.5V ≤ VDD ≤ 5.5V 0°C ≤ TA ≤ +85°C (industrial)
			± 5%	3.80	4.00	4.20	MHz	2.0V ≤ VDD ≤ 5.5V -40°C ≤ TA ≤ +85°C (industrial) -40°C ≤ TA ≤ +125°C (extended)

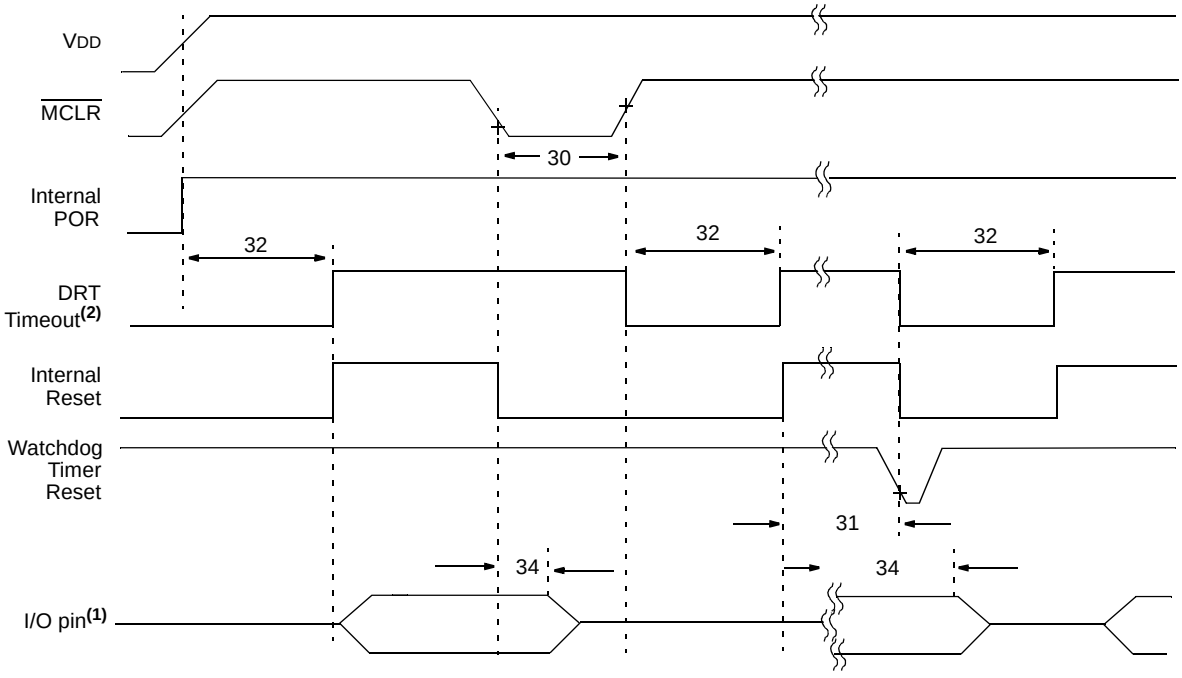
* These parameters are characterized but not tested.

† Data in the Typical ("Typ.") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: To ensure these oscillator frequency tolerances, VDD and VSS must be capacitively decoupled as close to the device as possible. 0.1 µF and 0.01 µF values in parallel are recommended.

2: Under stable VDD conditions.

FIGURE 12-3: RESET, WATCHDOG TIMER AND DEVICE RESET TIMER TIMING – PIC10F200/202/204/206



Note 1: I/O pins must be taken out of High-Impedance mode by enabling the output drivers in software.

2: Runs on POR only.

FIGURE 13-2: TYPICAL IPD VS. VDD (SLEEP MODE, ALL PERIPHERALS DISABLED)

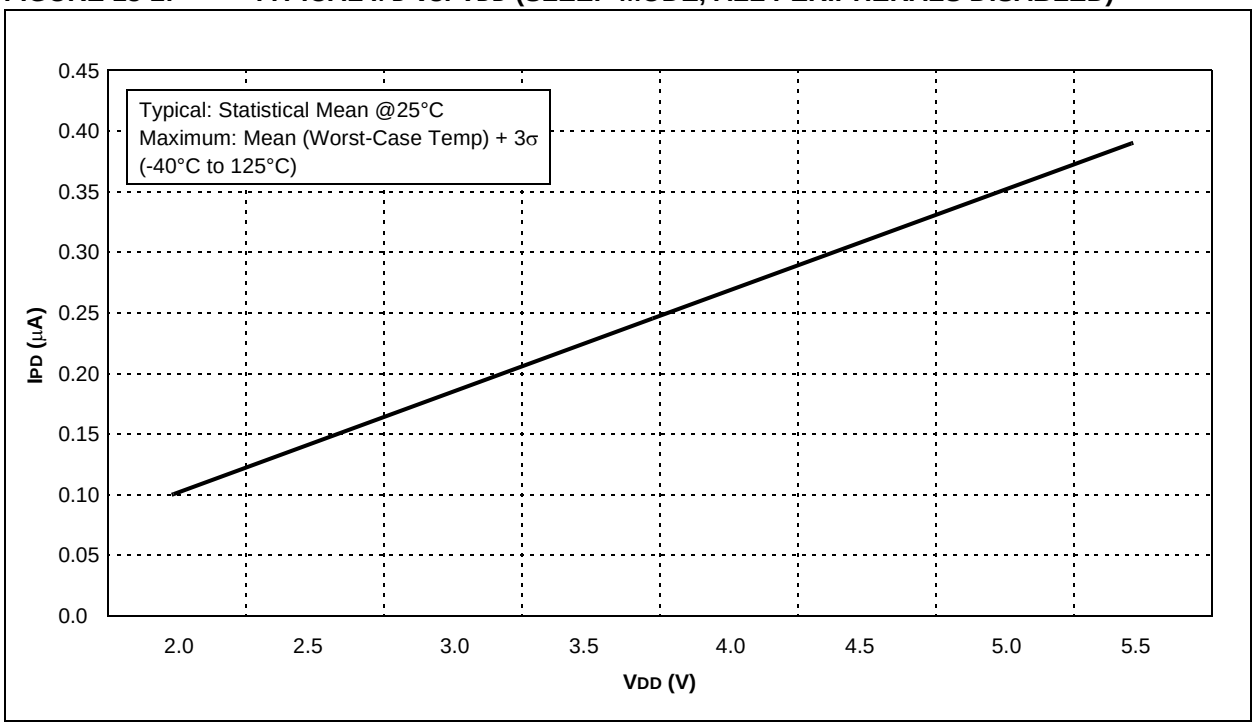


FIGURE 13-3: MAXIMUM IPD VS. VDD (SLEEP MODE, ALL PERIPHERALS DISABLED)

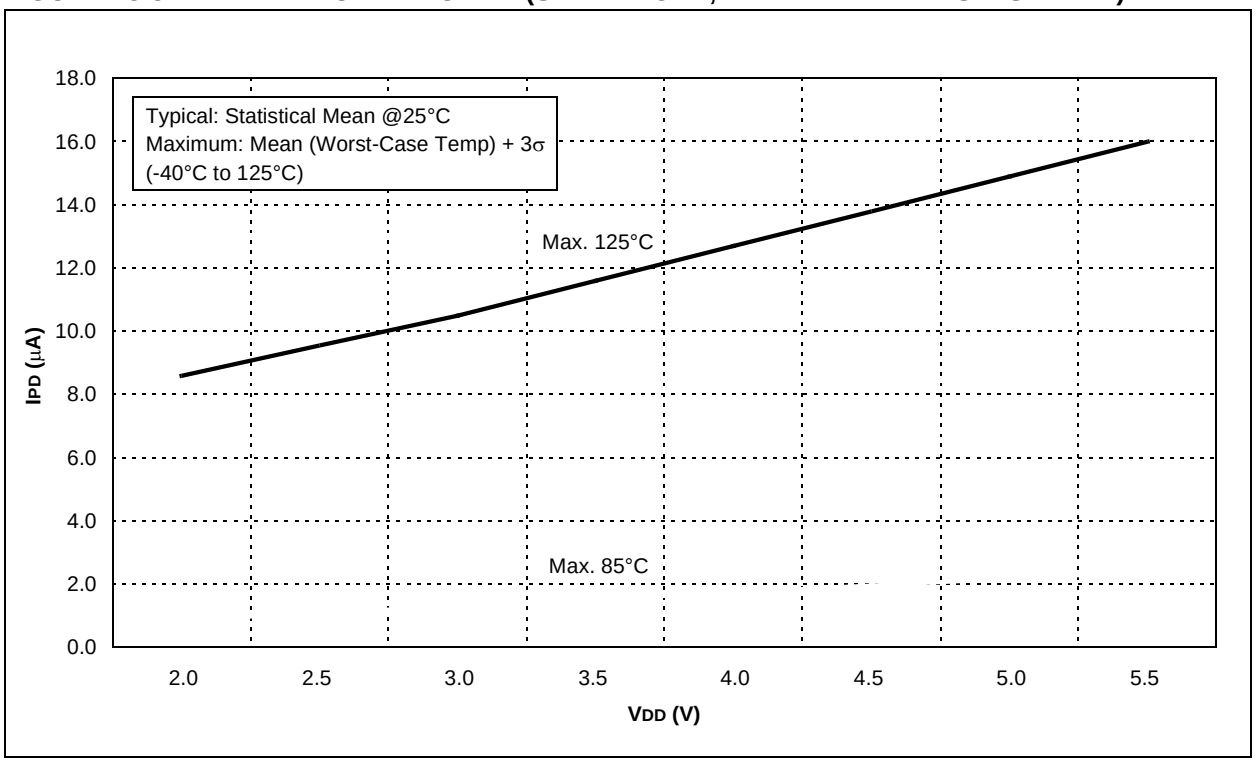


TABLE 14-1: 8-LEAD 2x3 DFN (MC) PACKAGE TOP MARKING

Part Number	Marking
PIC10F200-I/MC	BA0
PIC10F200-E/MC	BB0
PIC10F202-I/MC	BC0
PIC10F202-E/MC	BD0
PIC10F204-I/MC	BE0
PIC10F204-E/MC	BF0
PIC10F206-I/MC	BG0
PIC10F206-E/MC	BH0

TABLE 14-2: 6-LEAD SOT-23 (OT) PACKAGE TOP MARKING

Part Number	Marking
PIC10F200-I/OT	00NN
PIC10F200-E/OT	00NN
PIC10F202-I/OT	02NN
PIC10F202-E/OT	02NN
PIC10F204-I/OT	04NN
PIC10F204-E/OT	04NN
PIC10F206-I/OT	06NN
PIC10F206-E/OT	06NN

Note: NN represents the alphanumeric traceability code.

APPENDIX A: REVISION HISTORY

Revision C (August 2006)

Added 8-Pin DFN Pin Diagram; Revised Table 1-1; Reformatted all Registers; Revised Section 4.8 and added note; Section 5.3 (changed Figure reference to Figure 5-1); Tables 6-1 and 7-1 (removed shading from TRISGPIO (I/O Control Register); Sections 8.1-8.4 (changed Table reference to Table 12-2); Section 14.1 Revised and replaced Package Marking Information and drawings, Added Tables 14-1 & 14-2, Added DFN Package drawing.

Revision D (April 2007)

Revised section 12.1, 12.2, 12.3, Table 1-1, 12-1, 12-3, 12-4. Added Section 13.0. Replaced Package Drawings (Rev. AP); Removed instances of PICmicro® and replaced it with PIC®.

Revision E (October 2013)

Revised Figure 8-1 (deleted OSCCAL); Revised Packaging Legend.

Revision F (September 2014)

Added Table 12-6 (Thermal Considerations); Updated Register 4-1, Register 9-1 and Chapter 14 (Packaging Information); Other minor corrections.

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